

	9144030070855050X 9		
	A1 A3		0755-3381038 8
	<p style="text-align: center;">(Printed Circuit Board PCB) (High Density Interconnection HDI) (Flexible Printed Circuit FPC) (Rigid Printed Circuit Board</p> <p>3C ISO9001 ISO14001 ISO14064 OHSAS18001 QC080000</p>		

					1		
			/	mg/L		mg/L	
				50.99	70.48	160	
				13.94	19.27	30	
		DB44/1597-2015 1 DB44/1597-2015 1					
		200%					
					1		
			/	mg/m ³		mg/m ³	
				0.53	3.98	7	
				1.59	11.06	30	
				0.06	0.48	30	
		GB21900-2008 5					

		4,582.28
		6,468.84
		18.43
		36.17
		140.20
		456.53
		1,067.45
		191.40
		228.30
		1053
		413.65
		132.93
		21.00
		3.20
		0.57
		11.31
		3.77
PMA		8.82
		109.25
		0.72
		1.38
		116.65
		4.12
		1.32
		51.14

		34.64		
	Leq	Leq	Leq	Leq
1	57.0	48.0	65	55
1	58.2	49.5		
1	58.3	49.2		
1	57.5	49.0		

		2006 12	12000 /	
		2006 12	133.3 /	

()		2005-12-2 3	[2005] 213			
" () "		2006-8-10	[2006] 10217 2			
" () " 2017 "		2009-09-0 8	[2009] 10091 7		2007/ 7/19	[2007] 075
					2009/ 2/9	[2009] 021
					2011/ 4/11	[2011] 026

			2017-2-27
	1		" "
	2	"	"
	3		

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	http://www.epinfo.org 2013 12 16 2015 2015 10 23
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	1. COD pH 2 2011 3 31 2019 3 3 500 RMB
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	2017/6/23
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